



国家开发银行
CHINA DEVELOPMENT BANK

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BENCHMARK BOND ISSUANCE PROGRAMME
TENDER ANNOUNCEMENT

6 September 2023

Issue Number	09230220
Tender Type	Reopening
Tender Date	7 September 2023
Tender Time	9:30 am to 10:30 am
Offering Amount	Renminbi 1.5 Billion
Interest Type	Fixed
Coupon Rate	3.03%
Interest Payment Frequency	Annually
Interest Payment Date	24 July
Original Tenor	Twenty Years
Maturity Date	24 July 2043
Issue and Settlement Date	11 September 2023
Dated Date(Value Date)	24 July 2023
Listing Date	12 September 2023
Clearing House	Shanghai Clearing House
Market	China's Inter-bank Bond Market(CIBM)
Rating	Exempted for issuance in CIBM
For offshore issuance, China's Quasi-sovereign ratings, i.e. Moody's: A1(Stable), S&P: A+(Stable)	

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CDB's bond yield curve available at <http://www.cdb.com.cn>.